

Hazardous Substance Disclosure Table for: **FC1**

Rev 1. June 2016

以下信息已提供符合 SJ / T11364-2014 标记为所要求的工业和信息化部中国人民共和国在电子电气产品中有毒有害物质的限制使用。

The following information has been made available to comply with SJ/T11364-2014 Marking for the Restricted Use of Hazardous Substances in Electronic and Electrical Products as required by the Ministry of Industry and Information Technology of the People's Republic of China.

有害物质的名称及含量表

Table of hazardous substances' name and concentration

部件名称 Component Name	有害物 质 Hazardous Substances					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6+)	多溴 联苯 (PBB)	多溴二苯醚 (PBDE)
Housing 外壳	Х	Х	Х	0	Х	Х
PCBAs 主板	х	Х	Х	0	Х	х
Display 显示	х	Х	Х	0	Х	х
Sensors 传感器	х	Х	х	0	х	x
Power Supply 电源	х	Х	Х	0	Х	Х
Modem 调制解调器	х	Х	Х	0	Х	х

本表格依据 SJ/T 11364 的规定编制。

This table is prepared in accordance with the provisions of SJ/T 11364.

- O: 表示该有害物质在该部件所有均质材料中的含量均在 GB/T 26572 规定的限量要求以下。
 Indicates that said hazardous substance contained in all of the homogeneous materials for this part is below the limit requirement of GB/T 26572.
- X:**表示**该有害物质至少在该部件的某一均质材料中的含量超出 GB/T 26572 规定的限量要**求**。
 Indicates that said hazardous substance contained in all of the homogeneous materials for this part is above the limit requirement of GB/T 26572.

未列入表内的其他部件,皆不含任何超出限量要求的限制使用物质。

All other components, not listed in the table, do not contain restricted substances above the threshold level

环保使用期限说明此产品是

The Environmental Protection Use Period for this product is:



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